2SA1619, 2SA1619A

Silicon PNP epitaxial planer type

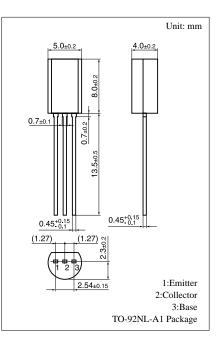
For low-frequency power amplification and driver amplification Complementary to 2SC4208 and 2SC4208A

Features

- Complementary pair with 2SC4208 and 2SC4208A.
- Allowing supply with the radial taping and automatic insertion possible.

Parameter		Symbol	Ratings	Unit			
Collector to	2SA1619	V	-30	3.7			
base voltage	2SA1619A	V _{CBO}	-60	V			
Collector to	2SA1619	17	-25	3.7			
emitter voltage	2SA1619A	V _{CEO}	-50	V			
Emitter to base voltage		V_{EBO}	-5	V			
Peak collector current		I _{CP}	-1	А			
Collector current		I _C	- 0.5	А			
Collector power dissipation		P _C	1	W			
Junction temperature		Tj	150	°C			
Storage temperature		T _{stg}	-55 ~ +150	°C			

Absolute Maximum Ratings (Ta=25°C)

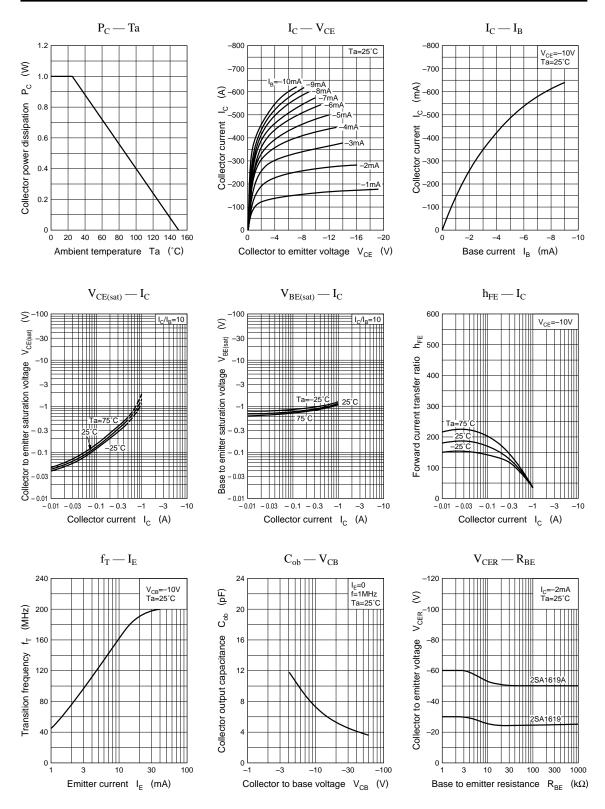


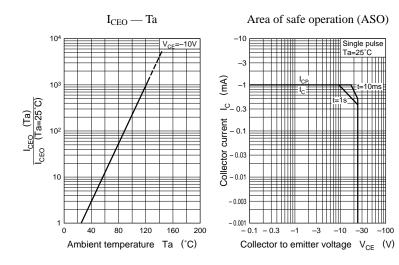
Electrical Characteristics (Ta=25°C)

Parameter		Symbol	Conditions	min	typ	max	Unit
Collector cutoff current		I _{CBO}	$V_{CB} = -20V, I_E = 0$			- 0.1	μΑ
Collector to base	2SA1619	X 7	$I_C = -10\mu A, I_E = 0$	-30			v
voltage	2SA1619A	V _{CBO}		-60			
Collector to emitter	2SA1619		$I_{\rm C} = -10 {\rm mA}, I_{\rm B} = 0$	-25			- v
voltage	2SA1619A	V _{CEO}		-50			
Emitter to base voltage		V _{EBO}	$I_{\rm E} = -10 \mu A, I_{\rm C} = 0$	-5			v
Forward current transfer ratio		h _{FE1} *	$V_{CE} = -10V, I_C = -150mA$	85	160	340	
		h _{FE2}	$V_{CE} = -10V, I_C = -500mA$	40			
Collector to emitter saturation voltage V _C		V _{CE(sat)}	$I_{\rm C} = -300 {\rm mA}, I_{\rm B} = -30 {\rm mA}$		- 0.35	- 0.6	v
		V _{BE(sat)}	$I_{\rm C} = -300 {\rm mA}, I_{\rm B} = -30 {\rm mA}$		-1.1	-1.5	v
Transition frequency		f _T	$V_{CB} = -10V, I_E = 50mA, f = 200MHz$		200		MHz
Collector output capacitance		C _{ob}	$V_{CB} = -10V, I_E = 0, f = 1MHz$		6	15	pF

*hFE1 Rank classification

Rank	Q	R	S
$\mathbf{h}_{\mathrm{FE1}}$	85 ~ 170	120 ~ 240	170 ~ 340





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